



STPR1620CG STPR1620CT

ULTRA-FAST RECOVERY RECTIFIER DIODES

MAIN PRODUCTS CHARACTERISTICS

$I_F(AV)$	2 x 8 A
V_{RRM}	200 V
$T_j(max)$	150°C
$V_F(max)$	0.99 V
$t_{rr}(max)$	30 ns

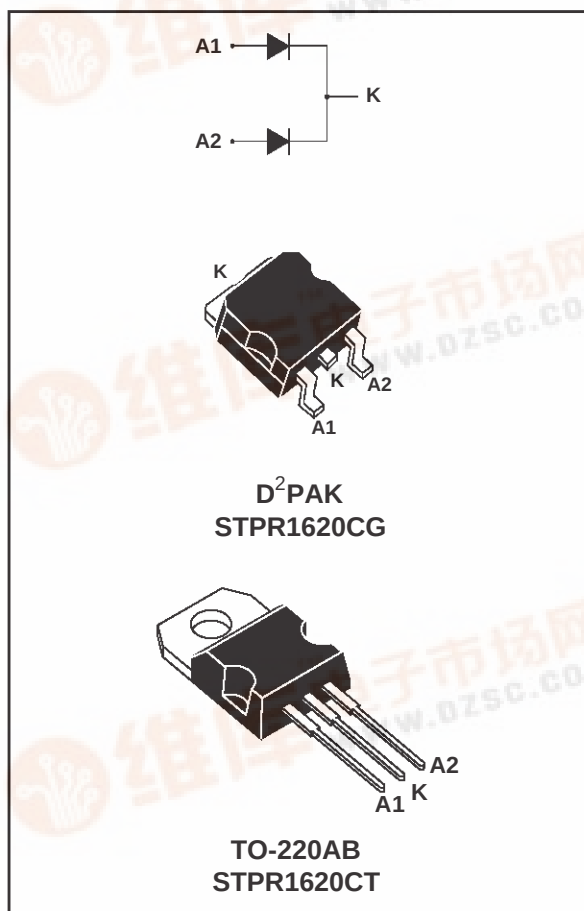
FEATURES

- SUITED FOR SMPS
- LOW LOSSES
- LOW FORWARD AND REVERSE RECOVERY TIME
- HIGH SURGE CURRENT CAPABILITY

DESCRIPTION

Low cost dual center tap rectifier suited for Switched Mode Power Supplies and high frequency DC to DC converters.

Packaged in D²PAK or TO-220AB, this device is intended for use in low voltage, high frequency inverters, free wheeling and polarity protection applications.



ABSOLUTE RATINGS (limiting values, per diode)

Symbol	Parameter			Value	Unit
V _{RRM}	Repetitive peak reverse voltage			200	V
I _{F(RMS)}	RMS forward current			20	A
I _{F(AV)}	Average forward current δ = 0.5	T _c =120°C	Per diode Per device	8 16	A
I _{FSM}	Surge non repetitive forward current	t _p =10ms sinusoidal		80	A
T _{stg}	Storage temperature range			- 65 to + 150	°C
T _j	Maximum operating junction temperature			150	°C

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THERMAL RESISTANCES

Symbol	Parameter		Value	Unit
$R_{th(j-c)}$	Junction to case	Per diode	3.0	°C/W
		Total	1.8	°C/W
$R_{th(c)}$		Coupling	0.6	°C/W

When the diodes 1 and 2 are used simultaneously :

$$\Delta T_j(\text{diode 1}) = P(\text{diode 1}) \times R_{th(j-c)} (\text{Per diode}) + P(\text{diode 2}) \times R_{th(c)}$$

STATIC ELECTRICAL CHARACTERISTICS

Symbol	Test conditions		Min.	Typ.	Max.	Unit
I_R *	$T_j = 25^\circ\text{C}$	$V_R = V_{RRM}$			50	μA
	$T_j = 100^\circ\text{C}$			0.2	0.6	mA
V_F **	$T_j = 125^\circ\text{C}$	$I_F = 8\text{ A}$		0.8	0.99	V
	$T_j = 125^\circ\text{C}$	$I_F = 16\text{ A}$		0.95	1.20	
	$T_j = 25^\circ\text{C}$	$I_F = 16\text{ A}$			1.25	

Pulse test : * $t_p = 5\text{ ms}$, $\delta < 2\%$

** $t_p = 380\text{ }\mu\text{s}$, $\delta < 2\%$

To evaluate the conduction losses use the following equation :

$$P = 0.78 \times I_{F(AV)} + 0.026 \times I_{F(RMS)}^2$$

RECOVERY CHARACTERISTICS

Symbol	Test conditions		Min.	Typ.	Max.	Unit
t_{rr}	$T_j = 25^\circ\text{C}$	$I_F = 0.5\text{ A}$ $I_R = 1\text{ A}$ $I_{rr} = 0.25\text{ A}$			30	ns
t_{fr}	$T_j = 25^\circ\text{C}$	$I_F = 3\text{ A}$ $V_{FR} = 1.1 \times V_F \text{ max}$ $dI_F/dt = 50\text{ A}/\mu\text{s}$		20		ns
V_{FP}	$T_j = 25^\circ\text{C}$	$I_F = 3\text{ A}$ $dI_F/dt = 50\text{ A}/\mu\text{s}$		3		V

Fig. 1: Average forward power dissipation versus average forward current (per diode).

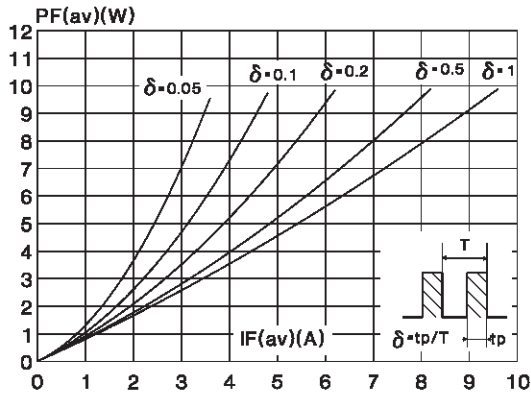


Fig. 2: Peak current versus form factor (per diode).

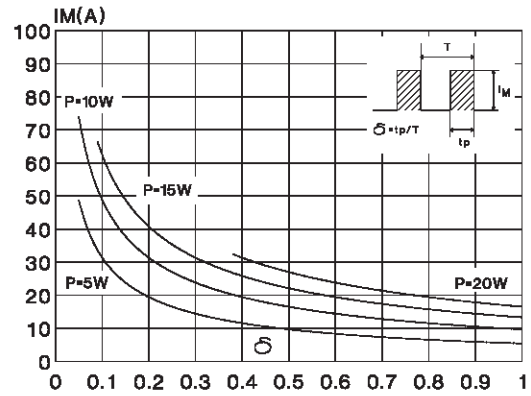


Fig. 3: Average current versus ambient temperature ($\delta : 0.5$, per diode).

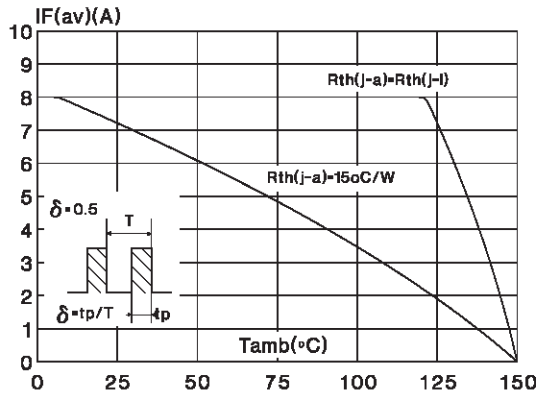


Fig. 4: Non repetitive surge peak forward current versus overload duration (maximum values, per diode).

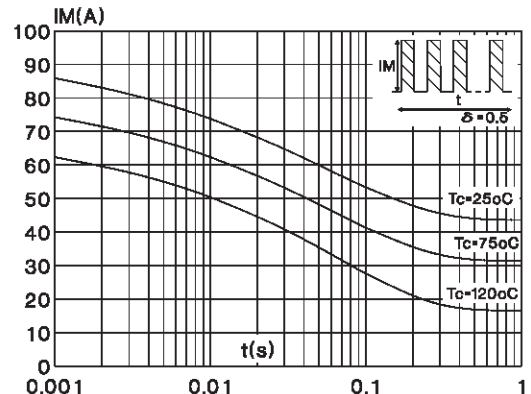


Fig. 5: Relative variation of thermal transient impedance junction to case versus pulse duration (per diode).

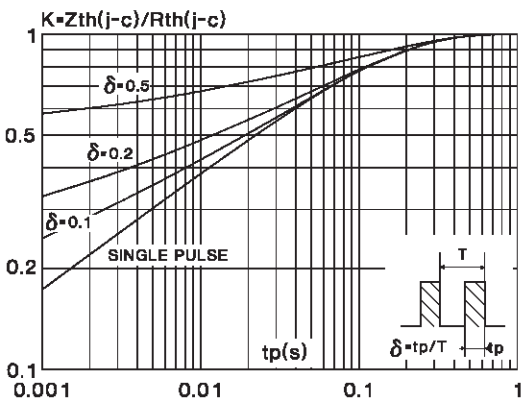


Fig. 6: Forward voltage drop versus forward current (maximum values, per diode).

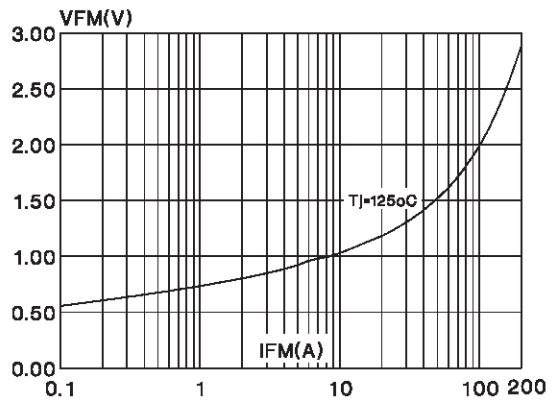


Fig. 7: Junction capacitance versus reverse voltage applied (typical values, per diode).

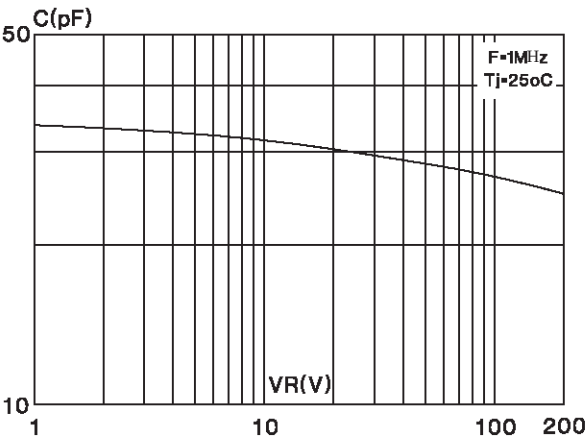


Fig. 8: Recovery charges versus dI_F/dt (per diode).

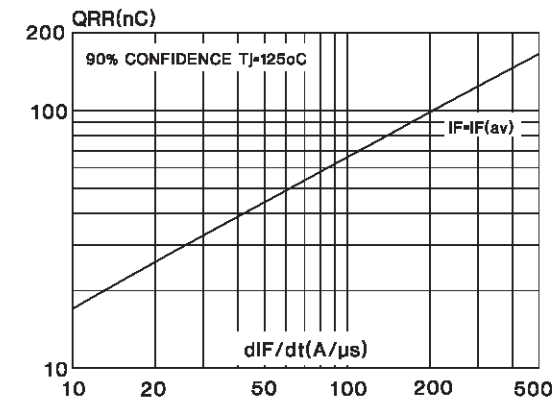


Fig. 9: Peak reverse current versus dI_F/dt (per diode).

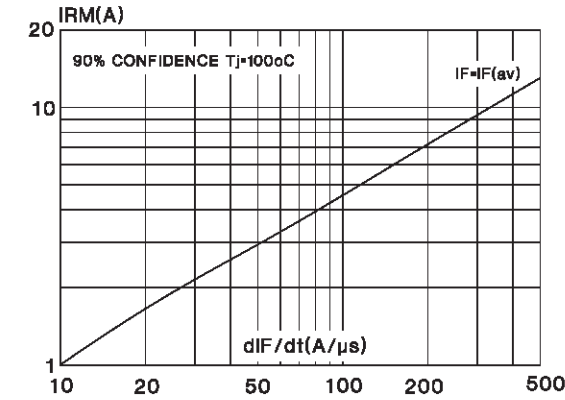
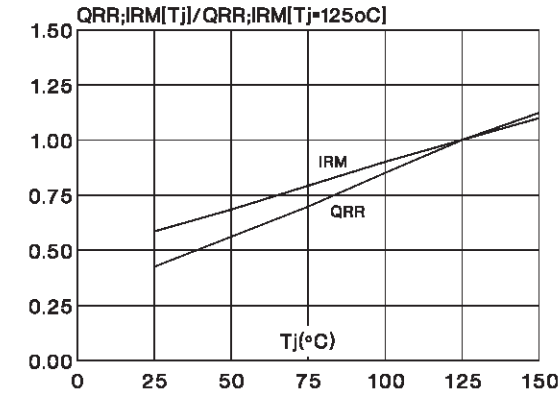
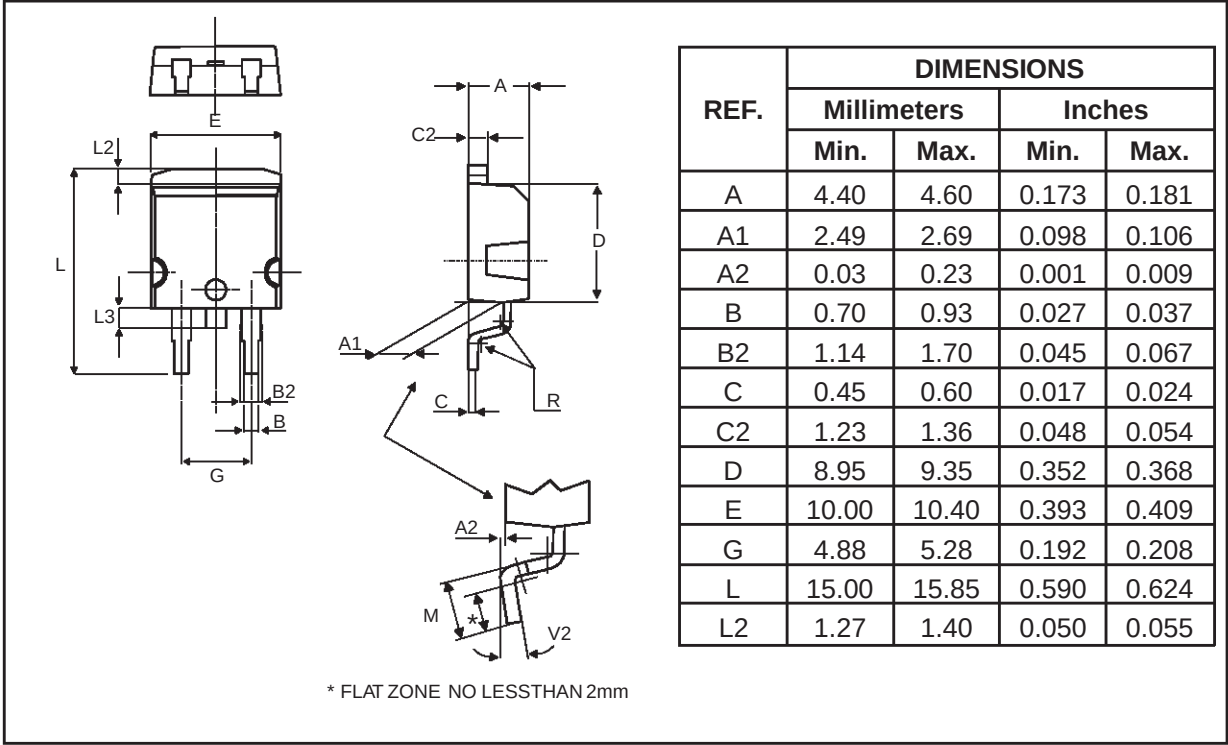


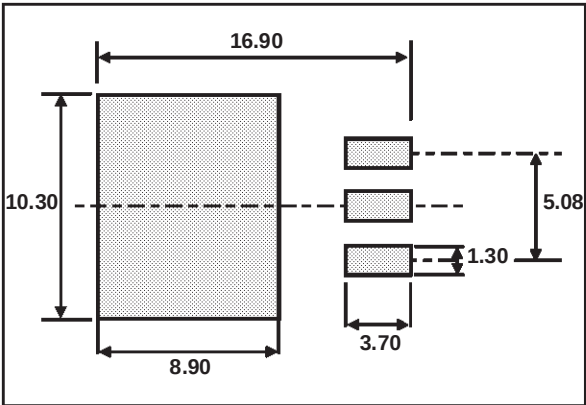
Fig. 10: Dynamic parameters versus junction temperature(per diode).



PACKAGE MECHANICAL DATA
D²PAK (Plastic)

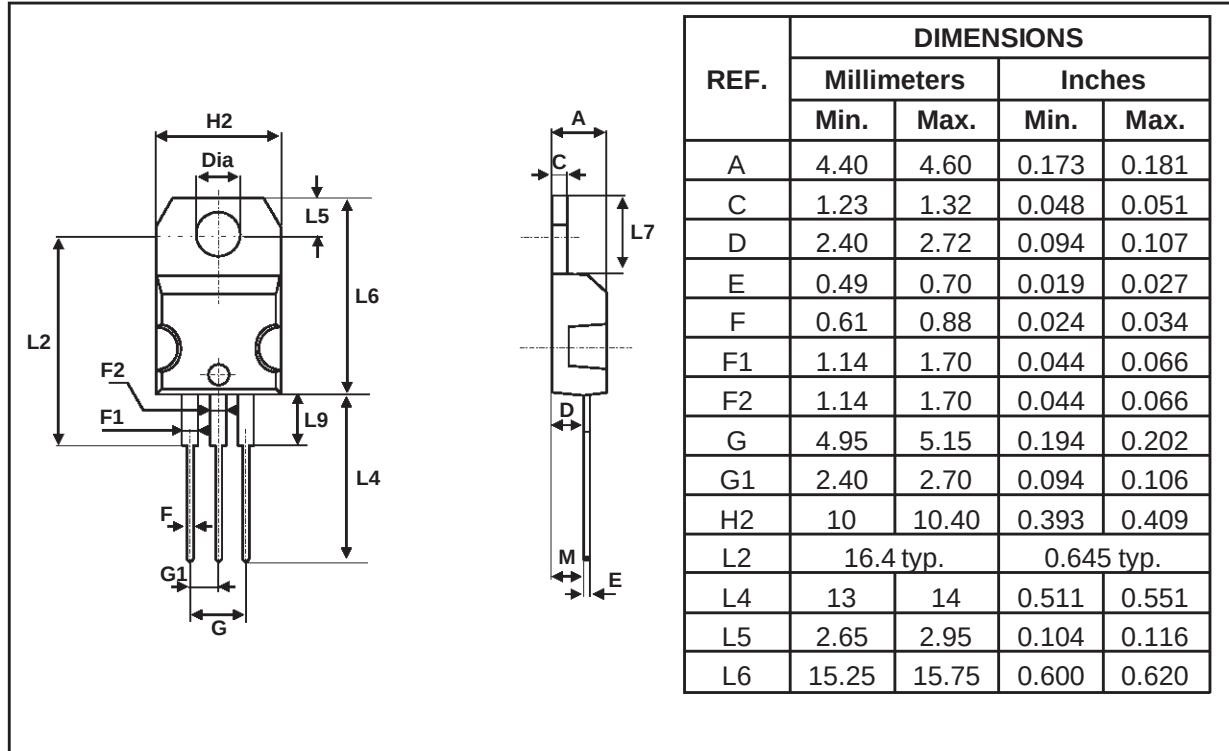


FOOT PRINT (in millimeters)



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PACKAGE MECHANICAL DATA TO-220AB (JEDEC outline)



Ordering type	Marking	Package	Weight	Base qty	Delivery mode
STPR1620CT	STPR1620CT	TO-220AB	2.23g	50	Tube
STPR1620CG	STPR1620CG	D ² PAK	1.48g	50	Tube
STPR1620CG-TR	STPR1620CG	D ² PAK	1.48g	1000	Tape & reel

- Cooling method : by conduction (C)
- Recommended torque value : 0.55N.m.
- Maximum torque value : 0.7N.m.
- Epoxy meets UL94,V0

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